

Single N-channel MOSFET

ELM17412GA-S

■General description

ELM17412GA-S uses advanced trench technology to provide excellent $R_{ds(on)}$, low gate charge and operation with gate voltages as low as 2.5V.

■Features

- $V_{ds}=30V$
- $I_d=2.1A$ ($V_{gs}=10V$)
- $R_{ds(on)} < 90m\Omega$ ($V_{gs}=10V$)
- $R_{ds(on)} < 100m\Omega$ ($V_{gs}=4.5V$)
- $R_{ds(on)} < 160m\Omega$ ($V_{gs}=2.5V$)

■Maximum absolute ratings

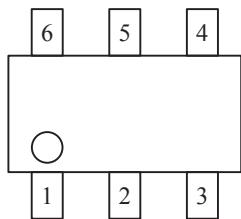
| Parameter | Symbol | Limit | Unit | Note |
|--|----------------|------------|------|------|
| Drain-source voltage | V_{ds} | 30 | V | |
| Gate-source voltage | V_{gs} | ± 12 | V | |
| Continuous drain current Ta=25°C | I_d | 2.1 | A | 1 |
| Ta=70°C | | 1.7 | | |
| Pulsed drain current | I_{dm} | 10 | A | 2 |
| Power dissipation Ta=25°C | P_d | 0.625 | W | 1 |
| Ta=70°C | | 0.400 | | |
| Junction and storage temperature range | T_j, T_{stg} | -55 to 150 | °C | |

■Thermal characteristics

| Parameter | | Symbol | Typ. | Max. | Unit | Note |
|-----------------------------|--------------|-----------------|------|------|------|------|
| Maximum junction-to-ambient | $t \leq 10s$ | $R_{\theta ja}$ | 175 | 200 | °C/W | 1 |
| Maximum junction-to-ambient | Steady-state | | 200 | 250 | °C/W | |
| Maximum junction-to-lead | Steady-state | $R_{\theta jl}$ | 130 | 160 | °C/W | 3 |

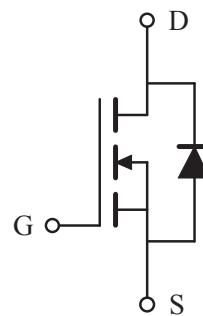
■Pin configuration

SC-70-6(TOP VIEW)



| Pin No. | Pin name |
|---------|----------|
| 1 | DRAIN |
| 2 | DRAIN |
| 3 | GATE |
| 4 | SOURCE |
| 5 | DRAIN |
| 6 | DRAIN |

■Circuit



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■Electrical characteristics

$T_a=25^\circ C$

| Parameter | Symbol | Condition | | Min. | Typ. | Max. | Unit |
|------------------------------------|--------------|-------------------------------------|----------------------------------|------|------|------|-----------|
| STATIC PARAMETERS | | | | | | | |
| Drain-source breakdown voltage | BV_{DSS} | $I_d=250\mu A, V_{GS}=0V$ | | 30 | | | V |
| Zero gate voltage drain current | Id_{SS} | $V_{DS}=16V, V_{GS}=0V$ | | | 1 | | μA |
| | | | $T_j=55^\circ C$ | | | 5 | |
| Gate-body leakage current | I_{GSS} | $V_{DS}=0V, V_{GS}=\pm 12V$ | | | | 100 | nA |
| Gate threshold voltage | $V_{GS(th)}$ | $V_{DS}=V_{GS}, I_d=250\mu A$ | | 1.0 | 1.5 | 1.8 | V |
| On state drain current | $I_d(on)$ | $V_{GS}=4.5V, V_{DS}=5V$ | | 10 | | | A |
| Static drain-source on-resistance | $R_{DS(on)}$ | $V_{GS}=10V, I_d=2.1A$ | | | 69 | 90 | $m\Omega$ |
| | | | $T_j=125^\circ C$ | | 108 | 130 | |
| | | $V_{GS}=4.5V, I_d=1.3A$ | | | 78 | 100 | $m\Omega$ |
| | | $V_{GS}=2.5V, I_d=1A$ | | | 130 | 160 | $m\Omega$ |
| Forward transconductance | G_f | $V_{DS}=5V, I_d=2.1A$ | | | 8.5 | | S |
| Diode forward voltage | V_{SD} | $I_S=1A, V_{GS}=0V$ | | | 0.8 | 1.0 | V |
| Max. body-diode continuous current | I_S | | | | | 2.5 | A |
| DYNAMIC PARAMETERS | | | | | | | |
| Input capacitance | C_{iss} | $V_{GS}=0V, V_{DS}=15V, f=1MHz$ | | | 226 | 270 | pF |
| Output capacitance | C_{oss} | | | | 39 | | pF |
| Reverse transfer capacitance | C_{rss} | | | | 29 | | pF |
| Gate resistance | R_g | $V_{GS}=0V, V_{DS}=0V, f=1MHz$ | | | 1.4 | 1.7 | Ω |
| SWITCHING PARAMETERS | | | | | | | |
| Total gate charge | Q_g | $V_{GS}=4.5V, V_{DS}=15V, I_d=2.1A$ | | | 3.0 | 3.6 | nC |
| Gate-source charge | Q_{gs} | | | | 0.4 | | nC |
| Gate-drain charge | Q_{gd} | | | | 1.2 | | nC |
| Turn-on delay time | $t_{d(on)}$ | $V_{GS}=5V, V_{DS}=15V$ | | | 2.8 | 4.0 | ns |
| Turn-on rise time | t_r | | | | 2.1 | 3.0 | ns |
| Turn-off delay time | $t_{d(off)}$ | | $R_L=7.1\Omega, R_{gen}=6\Omega$ | | 17.4 | 21.0 | ns |
| Turn-off fall time | t_f | | | | 2.1 | 3.0 | ns |
| Body diode reverse recovery time | t_{rr} | $I_F=2.1A, dI/dt=100A/\mu s$ | | | 9.1 | 11.0 | ns |
| Body diode reverse recovery charge | Q_{rr} | $I_F=2.1A, dI/dt=100A/\mu s$ | | | 3.4 | 4.0 | nC |

NOTE :

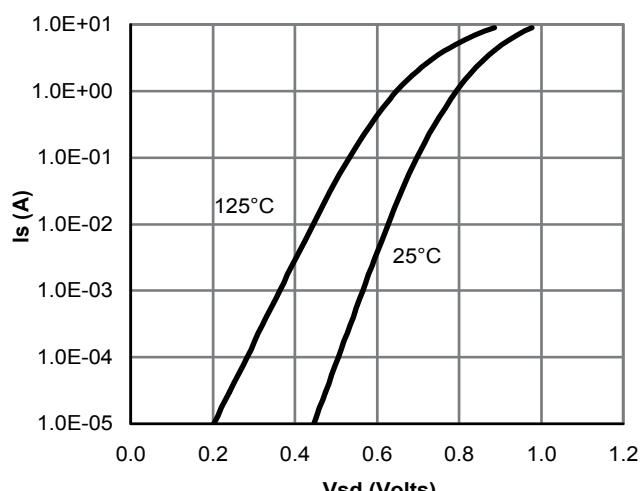
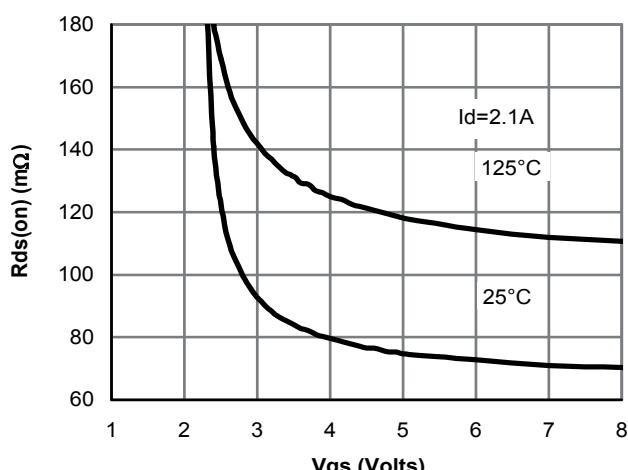
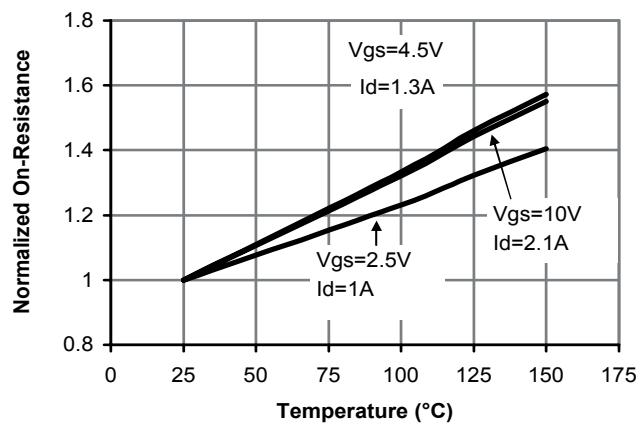
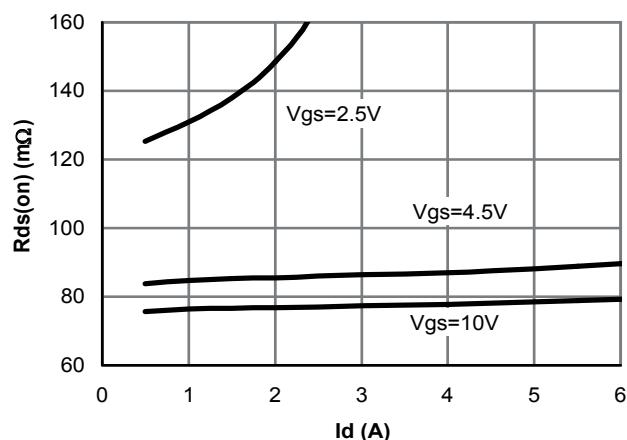
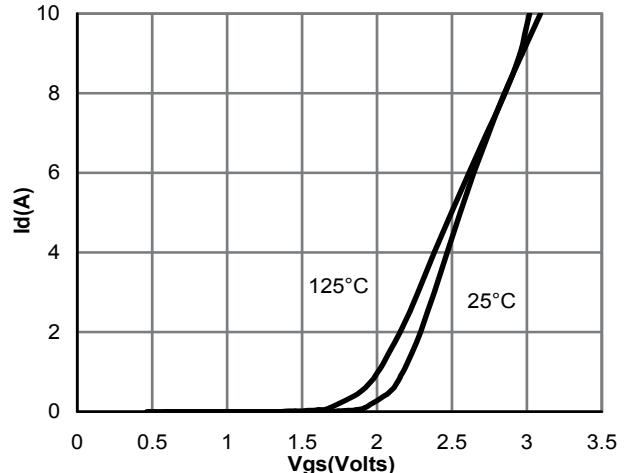
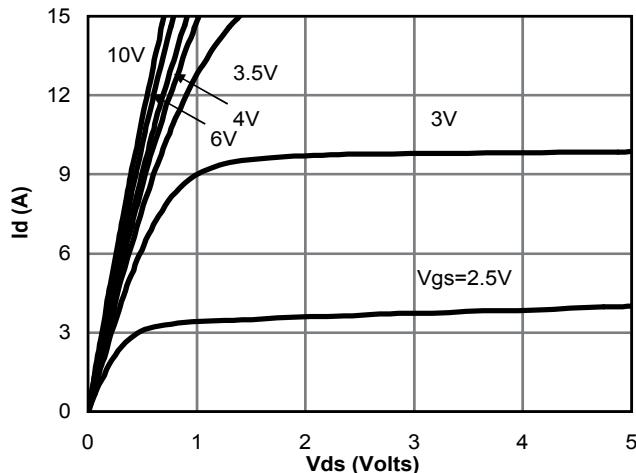
1. The value of $R_{\theta ja}$ is measured with the device mounted on 1in² FR-4 board of 2oz. Copper, in still air environment with $T_a=25^\circ C$. The value in any given applications depends on the user's specific board design. The current rating is based on the $t \leq 10s$ thermal resistance rating.
2. Repetitive rating, pulse width limited by junction temperature.
3. The $R_{\theta ja}$ is the sum of the thermal impedance from junction to lead $R_{\theta jl}$ and lead to ambient.
4. The static characteristics in Figures 1 to 6 are obtained using 80 μs pulses, duty cycle 0.5%max.
5. These tests are performed with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_a=25^\circ C$. The SOA curve provides a single pulse rating.



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■ Typical electrical and thermal characteristics



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